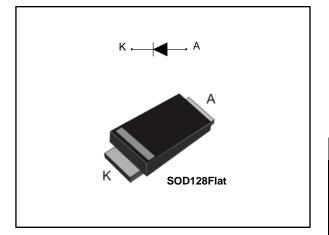


STPS360-Y

Automotive power Schottky rectifier

Datasheet - production data



Description

This high voltage Schottky barrier rectifier device is packaged in SOD128Flat and designed for high frequency miniature switched mode power supplies and on board DC to DC converters for automotive applications.

Symbol	Value
lf(AV)	3 A
Vrrm	60 V
T _j (max.)	175 °C
V _F (typ.)	0.49 V

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche specification
- ECOPACK[®] compliant component
- AEC-Q101
- PPAP capable
- V_{RRM} guaranteed from -40 to +175 °C

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This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	F	Value	Unit	
Vrrm	Repetitive peak reverse voltage ($T_j = -40 \text{ °C to } +175 \text{ °C}$)		60	V
IF(AV)	Average forward current	T_L = 140 °C, δ = 0.5, square pulse	3	А
IFSM	Surge non repetitive forward current	t _p = 10 ms sinusoidal	65	А
Parm	Repetitive peak avalanche power	t _p = 10 μs, T _j = 125 °C	140	W
T _{stg}	Storage temperature range		-65 to +175	°C
Tj	Operating junction temperature range ⁽¹⁾		-40 to +175	°C

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3: Thermal parameters				
Symbol	ool Parameter Max. value U			
Rth(j-I)	Junction to lead	16	°C/W	

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = 60 V	-		150	μA
		T _j = 125 °C		-	20	30	mA
VF ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 3 A	-		0.61	v
		T _j = 125 °C		-	0.49	0.58	
		T _j = 25 °C	IF = 6 A	-		0.80	
		T _j = 125 °C		-	0.62	0.72	

Table 4: Static electrical characteristics

Notes:

$$\label{eq:powerset} \begin{split} & \mbox{$^{(1)}$Pulse test: $t_p=5$ ms, $\delta<2\%$} \\ & \mbox{$^{(2)}$Pulse test: $t_p=380$ µs, $\delta<2\%$} \end{split}$$

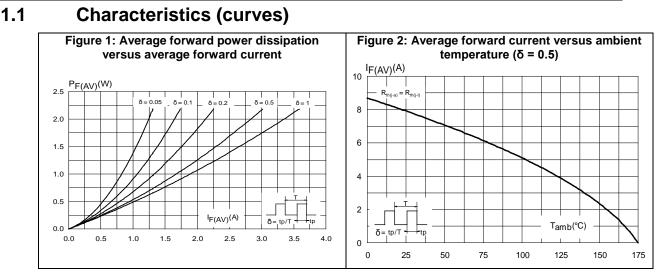
To evaluate the conduction losses, use the following equation:

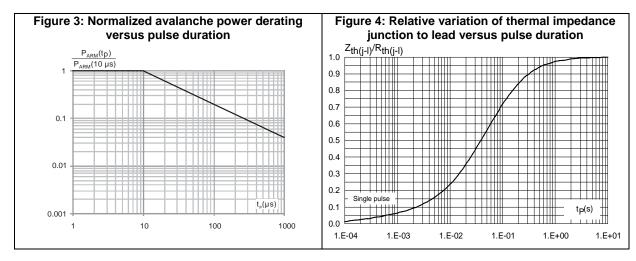
 $P = 0.44 \text{ x } I_{F(AV)} + 0.047 \text{ x } I_{F^{2}(RMS)}$

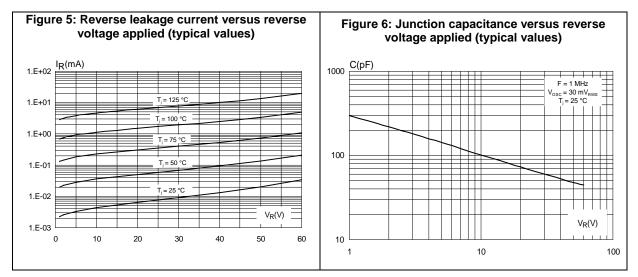


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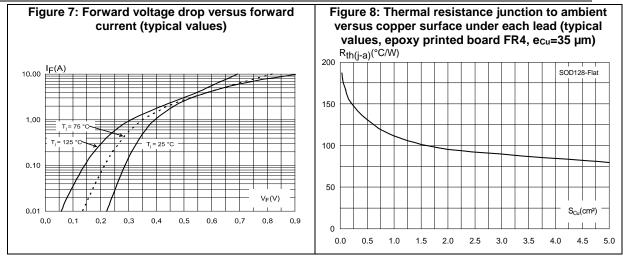
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Characteristics

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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Epoxy meets UL94, V0
- Lead-free package

2.1 SOD128Flat package information

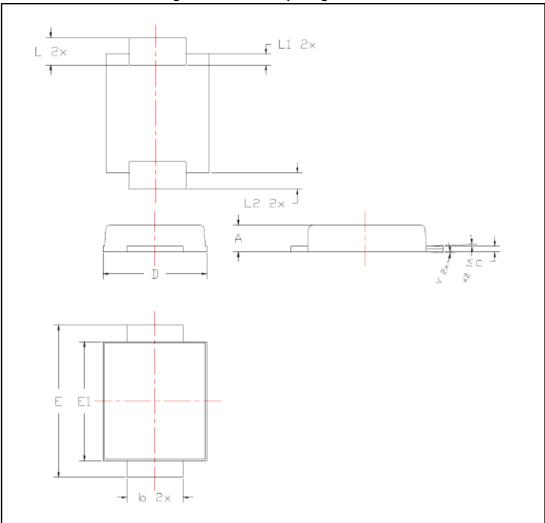


Figure 9: SOD128Flat package outline



Package information

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	Table 5: So	DD128Flat package	e mechanical data				
		Dimensions					
Ref.	Millin	Millimeters		hes			
	Min.	Max.	Min.	Max.			
А	0.93	1.03	0.037	0.041			
b	1.69	1.81	0.067	0.071			
С	0.10	0.22	0.004	0.009			
D	2.30	2.50	0.091	0.098			
E	4.60	4.80	0.181	0.189			
E1	3.70	3.90	0.146	0.154			
L	0.55	0.85	0.026	0.033			
L1	0.30	0.30 typ.		2 typ.			
L2	0.45	0.45 typ.		З typ.			

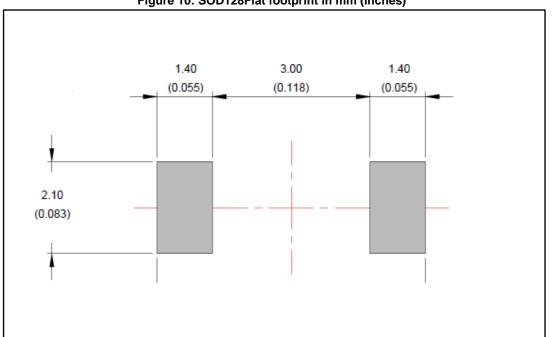


Figure 10: SOD128Flat footprint in mm (inches)

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3 Ordering information

Table 6: Ordering information					
Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS360AFY	360FY	SOD128Flat	26.4 mg	3000	Tape and reel

4 Revision history

Date	Revision	Changes
07-Jun-2016	1	Initial release.



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